

9/22/03

09-25-2003

Case 5824 P2 DISPLAY/AKT

FORM PTO-1595
(Rev. 6-93)
OMB No. 0651-0011 (exp. 4/94)U.S. Department of Commerce
Patent And Trademark Office

To the Honorable Commissioner of Patents and Trademarks

102560377

sent or copy thereof.

1. Name of conveying party(ies):

Jeffrey D. Chinn
Rolf A. Guenther
Michael B. Rattner
James A. Cooper
Toi Yue Becky Leung
Claes A. BjorkmanExecution Date
August 7, 2003
August 13, 2003
August 12, 2003
July 30, 2003
July 30, 2003
August 4, 2003Additional name(s) of conveying party(ies) attached? __ Yes X No

3. Nature of conveyance:

X Assignment
__ Security Agreement
__ Other
__ Merger
__ Change of NameExecution Date: See Above

2. Name and address of receiving party(ies):

Name: Applied Materials, Inc.Internal Address: P.O. Box 450-A

Street Address:

City: Santa Clara State: CA Zip: 95052Additional name(s) & address(es) attached? __ Yes X No

4. Application number(s) or registration number(s):

If this document is being filed together with a new application, the execution date of the application is: _____ (Date of Filing)

A. Patent Application No.(s) 10/435,757 filed 05/09/2003

B. Patent No.(s)

Additional numbers attached? __ Yes X No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Patent CounselInternal Address: APPLIED MATERIALS, INC.Street Address: P.O. Box 450-ACity: Santa Clara State: CA Zip: 950526. Total number of applications and patents involved: 17. Total fee (37 C.F.R. 3.41). \$ 40.00__ EnclosedX Authorized to be charged to deposit account
50-1074

8. Deposit account number:

50-1074

(Attach duplicate copy of this form if paying by deposit account)

09/24/2003 6TON11 00000126 501074 10435757

01 FE:6021 40.00 BA

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

ROBERT W. MULCAHY Reg. No. 25,436

Name of Person Signing

Signature

Date

10. Total number of pages including cover sheet, attachments and document: 13Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231PATENT
REEL: 014508 FRAME: 0695

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Jeffrey D. Chinn 605 St. Croix Lane Foster City, California 94404	2)	Rolf A. Guenther 17801 Vineland Avenue Monte Sereno, California 95030
3)	Michael B. Rattner 1506 Vista Club Circle #304 Santa Clara, California 95054	4)	James A. Cooper 1176 Lone Pine Lane San Jose, California 95120
5)	Toi Yue Becky Leung 1571 Tanaka Place Sunnyvale, California 94087	6)	Claes H. Bjorkman 14 Los Altos Square Los Altos, CA 94022

(hereinafter referred to as Assignors), have invented a certain invention entitled:

INTEGRATED METHOD FOR RELEASE AND PASSIVATION OF MEMS STRUCTURES

for which an application for Letters Patent in the United States was filed on May 9, 2003, under Serial No. 10/435,757; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

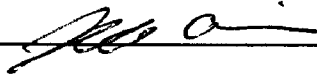
1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the date indicated below.

1)	<u>8/7/03</u> , 2003	<u>Jeffrey D. Chinn</u> 
2)	_____, 2003	<u>Rolf A. Guenther</u>
3)	_____, 2003	<u>Michael B. Rattner</u>
4)	_____, 2003	<u>James A. Cooper</u>
5)	_____, 2003	<u>Toi Yue Becky Leung</u>
5)	_____, 2003	<u>Claes H. Bjorkman</u>

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1) _____, 2003

Jeffrey D. Chinn

2) 8/13/, 2003


Rolf A. Guenther

3) _____, 2003

Michael B. Rattner

4) _____, 2003

James A. Cooper

5) _____, 2003

Toi Yue Becky Leung

5) _____, 2003

Claes H. Bjorkman

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1) _____, 2003

Jeffrey D. Chinn

2) _____, 2003

Rolf A. Guenther

3) 8/12' _____, 2003

Michael B. Ratner

4) _____, 2003

James A. Cooper

5) _____, 2003

Toi Yue Becky Leung

5) _____, 2003

Claes H. Bjorkman

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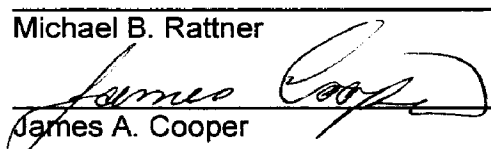
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2)	_____, 2003	_____ Rolf A. Guenther
3)	_____, 2003	_____ Michael B. Rattner
4)	<u>7/30</u> , 2003	 James A. Cooper
5)	_____, 2003	_____ Toi Yue Becky Leung
5)	_____, 2003	_____ Claes H. Bjorkman

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

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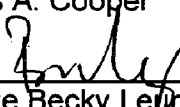
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4)	_____, 2003	_____ James A. Cooper
5)	<u>July 30</u> , 2003	 _____ Toi Yue Becky Leung
5)	_____, 2003	_____ Claes H. Bjorkman

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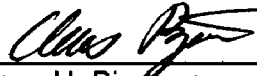
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5)	_____, 2003	_____ Toi Yue Becky Leung
5)	<u>Aug. 4</u> , 2003	 _____ Claes H. Bjorkman